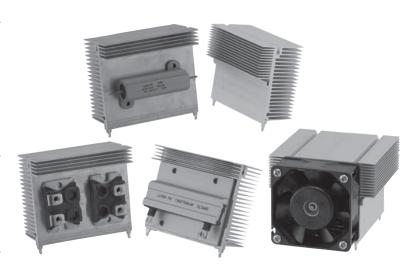
## B60/C60 Series

## **Heat Sink System**

Ohmite introduces the powerful B60/C60 series heatsink with cam clip (Pat. Pending) or custom mounting. This series offers flexible, high performance and compact heat sink with exchangeable cam clip system for TO-247 and TO-264 devices. The built in lip is provided for mounting ease. The optional B series can be tapped for popular Ohmite resistors or other devices. These powerful heat sinks can be thru-hole soldered as a single or dual unit. The dual unit can be mated to a 60mm fan for greater thermal performance. It is the ideal type of heat sink for high power density and small size (3U or 4U) electronic packaging with forced convection.



### **SERIES SPECIFICATIONS**

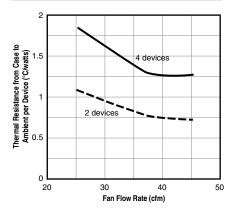
Heatsink Part Number	Surface Area (mm²/ in²)	Weight (oz/g)	Length L (mm)
C60-075-VE C60-075-AE	114,300 / 177	5.7 / 163	75
B60-075-VE B60-075-AF	114,300 / 177	5.7 / 163	75

consult factory for alternate lengths and clip combinations

#### **CHARACTERISTICS**

Heat Sink	Aluminum Alloy 6063-T5 or Equivalent with either degreased or black anodized finish.
Spring Clip	Music Wire, Per ASTM A228 with bright nickel plating
Solder Foot	Cold-rolled Steel, Per ASTM A-366 with pure tin over copper strike. RoHS compliant.
Fan	60mm fan with 4 self-tapping M3.5 screws
Interface Thermal Resistance	For improvement, use thermal joint compound, 0.005 Grafoil (TGon 800 by Laird), or phase change material (Hi-Flow by Bergquist) Insulator (Optional) Sil-Pad 900-S, K6 800-S and K10 by Bergquist

## **Heat Dissipation**

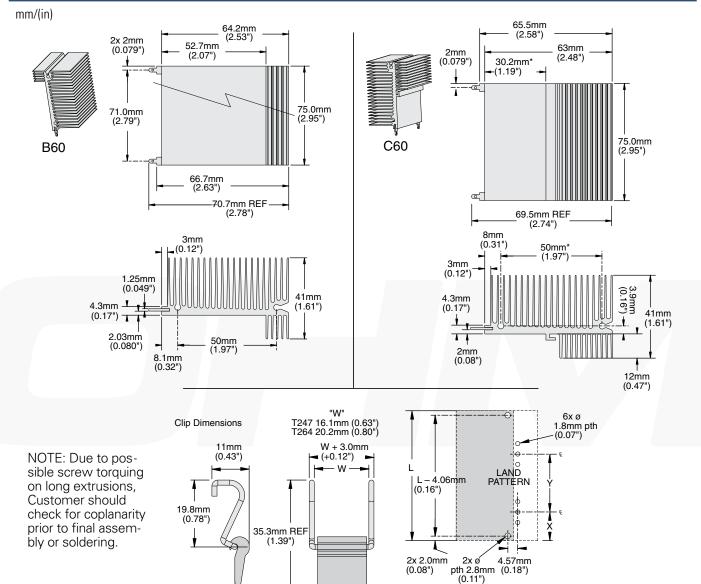


(continued)

# B60/C60 Series

## **Heat Sink System**

#### **DIMENSIONS**



### **HOW TO ORDER**

